度| 67HE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: King Leong et al.

DIFFUSION BARRIER LAYER FOR LEAD FREE PACKAGE SUBSTRATE

Docket No.:

884.A68US1

Serial No.: 10/673,605

Filed:

Title:

September 29, 2003

Due Date: September 15, 2005

Examiner:

Nitin Parekh

Group Art Unit: 2811

MS Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

X Return postcard.

X Amendment and Response (13 pgs.).

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: Richard E. Billion

Reg. No. 32,836

<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this <u>15th</u> day of September, 2005.

Name

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)

S/N 10/673,605 **PATENT**

IN THE COMPLETE STATES PATENT AND TRADEMARK OFFICE

Applicant: Kum Foo Leong et al.

Examiner: Nitin Parekh

Serial No.:

10/673,605

Group Art Unit: 2811

Filed:

September 29, 2003

Docket No.: 884.A68US1

Title:

DIFFUSION BARRIER LAYER FOR LEAD FREE PACKAGE SUBSTRATE

Assignee:

Intel Corporation

Customer No: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This responds to the Office Action mailed on June 15, 2005. Please amend the aboveidentified patent application as follows.